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## **ON Semiconductor**®

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### N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET 100 V, 80 A, 4.85 m $\Omega$

#### **Features**

- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)}$  = 4.85 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 16 A
- Max  $r_{DS(on)}$  = 7.8 m $\Omega$  at V<sub>GS</sub> = 6 V, I<sub>D</sub> = 13 A
- Advanced Package and Silicon combination for low r<sub>DS(on)</sub> and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

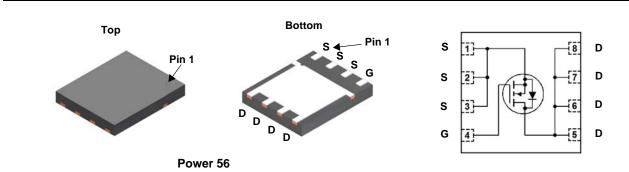


#### **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

#### Applications

- Primary DC-DC MOSFET
- Secondary Synchronous Rectifier
- Load Switch



#### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
I <sub>D</sub>	Drain Current -Continuous	T <sub>C</sub> = 25 °C		80		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	16	А	
	-Pulsed			300		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	726	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		156		
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.7		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.8	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	45	C/vv

#### Package Marking and Ordering Information

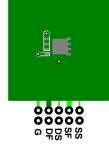
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86150	FDMS86150	Power 56	13 "	12 mm	3000 units

FDMS86150 N
N-Cha
<b>V-Channel S</b>
Shielded Gate PowerTrench
Gate
PowerT
rench <sup>®</sup>
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics				1	1	
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, V_{GS} = 0 \ V$	100			V	
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		72		mV/°C	
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2	3	4	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-10		mV/°C	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 16 A		3.9	4.85		
		V <sub>GS</sub> = 6 V, I <sub>D</sub> = 13 A		6	7.8	mΩ	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 16 A, T <sub>J</sub> = 125 °C		7.3	9.1		
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 16 A		53		S	
C <sub>iss</sub> C <sub>oss</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	→ V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz		3055 696 29	4065 930 50	pF pF	
C <sub>rss</sub>	Reverse Transfer Capacitance	t = 1 MHz		29	50	pF	
R <sub>g</sub>	Gate Resistance		0.1	0.7	3.6	Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			18	33	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 16 A,		8.3	17	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		28	45	ns	
t <sub>f</sub>	Fall Time			6	12	ns	
Qg	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		44	62	nC	
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 50 V,$		25	35	nC	
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 16 A		12.9		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			9.2		nC	
Drain-Sou	arce Diode Characteristics						
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 2.1 A (Note 2)		0.69	1.2	2	
		$V_{GS} = 0 V, I_S = 16 A$ (Note 2)		0.78	1.3	- V	
t <sub>rr</sub>	Reverse Recovery Time			69	110	ns	
				1			

Notes:

1. R<sub>0JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.



a. 45 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

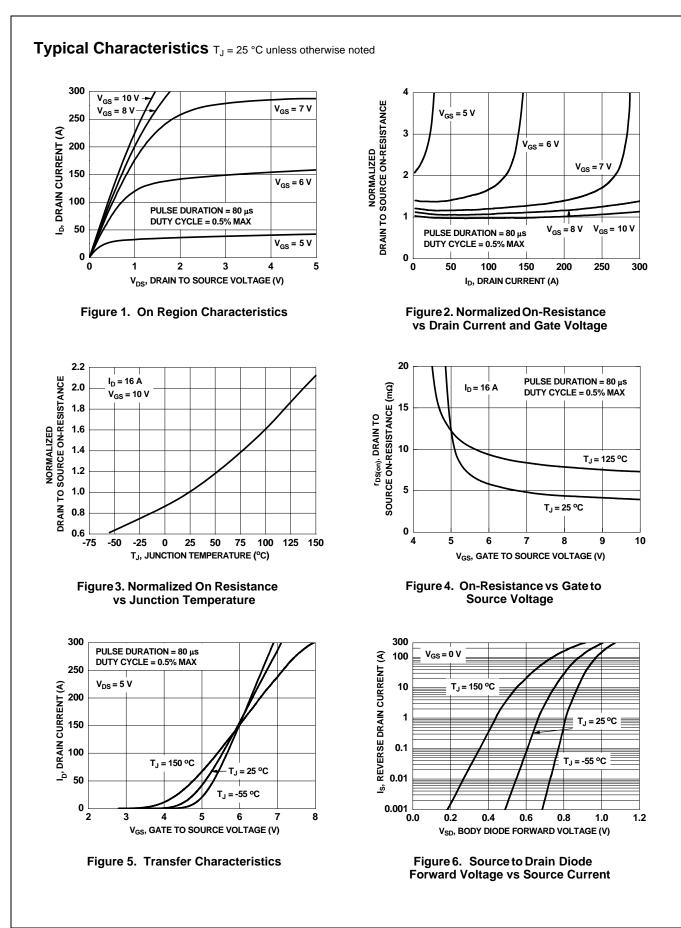


b. 115 °C/W when mounted on a minimum pad of 2 oz copper.

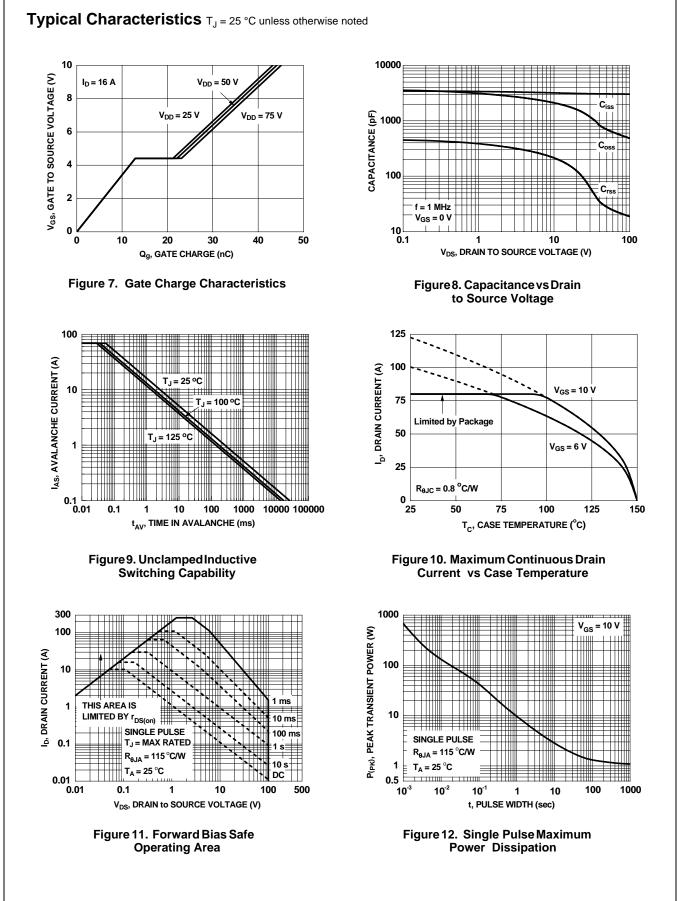
2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

3.  $E_{AS}$  of 726 mJ is based on starting  $T_J$  = 25 °C, L = 3 mH,  $I_{AS}$  = 22 A,  $V_{DD}$  = 100 V,  $V_{GS}$  = 10 V, 100% test at L = 0.1 mH,  $I_{AS}$  = 69 A.

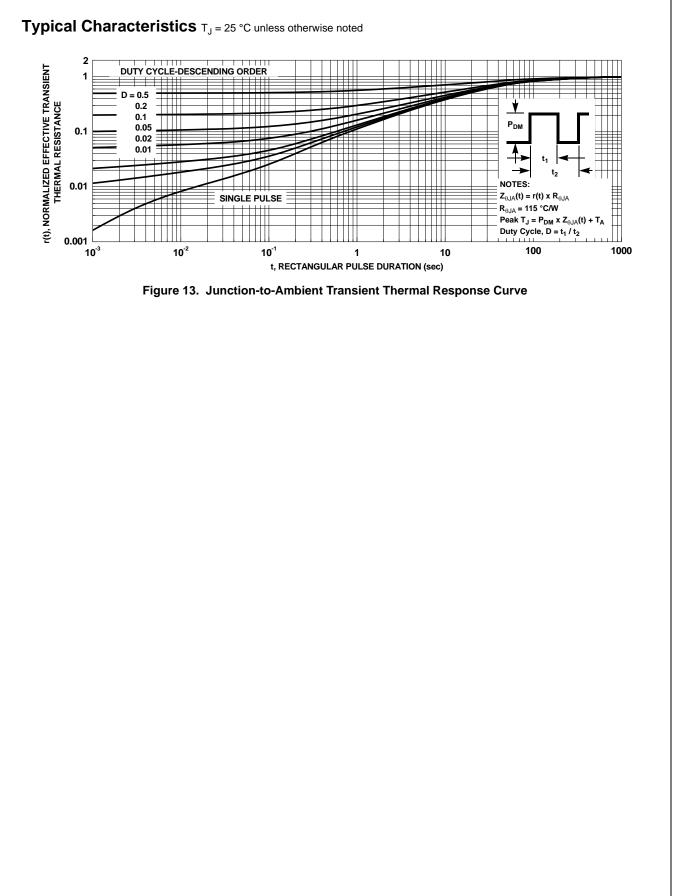
FDMS86150 N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET

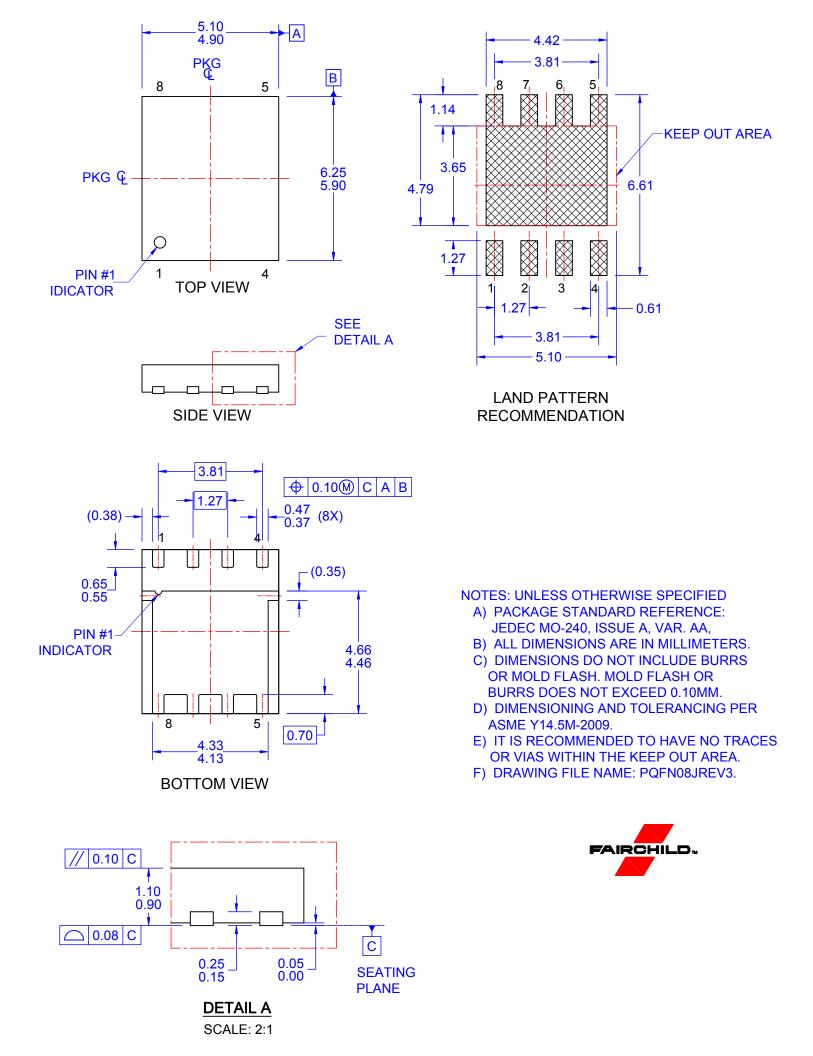


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FDMS86150 N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET





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